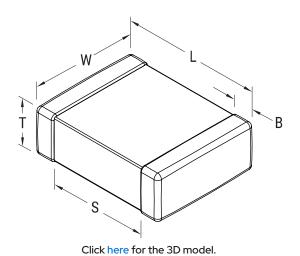


C1812C184KARACTU

Aliases (C1812C184KARAC7800) SMD Comm X7R, Ceramic, 0.18 uF, 10%, 250 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 1812, 2.3 mm



General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	95 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1812
L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
Т	1.55mm +/-0.10mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

Packaging Quantity

L	4.5mm +/-0.3mm	Measureme
W	3.2mm +/-0.3mm	Tolerance
Т	1.55mm +/-0.10mm	Voltage DC
S	2.3mm MIN	Dielectric W
В	0.6mm +/-0.35mm	Temperatur
		Temp. Coef
Packaging Specifications		Capacitance
Packaging	T&R, 180mm, Plastic Tape	Reference to

1000

Specifications	
Capacitance	0.18 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0 Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	5.5556 GOhms

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